

TRANSMITTAL LETTER
(General - Patent Pending)

Docket No.
11675.143.2

In Re Application Of: **Chen Cobbley**

Serial No.
10/056,350

Filing Date
January 24, 2002

Examiner
Unknown

Group Art Unit
2825

Title: **PROCESS FOR PROVIDING ELECTRICAL CONNECTION BETWEEN A SEMICONDUCTOR
DIE AND A SEMICONDUCTOR DIE RECEIVING MEMBER**

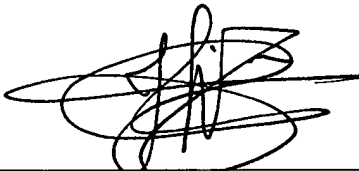
TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Transmittal Letter (1 pg dup);
Transmittal of IDS (2 pgs dup); IDS (2 pgs);
Information Disclosure Citation (1 pg); Cited References;
Certificate of Express Mailing # EL813858240US;
Postcard

in the above identified application.

- ☒ No additional fee is required.
- ☐ A check in the amount of _____ is attached.
- ☒ The Assistant Commissioner is hereby authorized to charge and credit Deposit Account No. **23-3178** as described below. A duplicate copy of this sheet is enclosed.
- ☐ Charge the amount of _____
- ☒ Credit any overpayment.
- ☒ Charge any additional fee required.


Signature

Dated: April 19, 2002

Jesus Juanos i Timoneda, Ph.D.
Attorney for Applicant
Reg No. 43,332



022901

PATENT TRADEMARK OFFICE

CC:

I certify that this document and fee is being deposited on _____ with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Signature of Person Mailing Correspondence

Typed or Printed Name of Person Mailing Correspondence

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT
(Under 37 CFR 1.97(b) or 1.97(c))

Docket No.
11675.143.2

In Re Application Of **Chad Cobbley**

Serial No.
10/056,350

Filing Date
January 24, 2002

Examiner
Unknown

Group Art Unit
2825

Title: **PROCESS FOR PROVIDING ELECTRICAL CONNECTION BETWEEN A SEMICONDUCTOR DIE AND A SEMICONDUCTOR DIE RECEIVING MEMBER**

Address to:
Assistant Commissioner for Patents
Washington, D.C. 20231

37 CFR 1.97(b)

1. ☒ The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application other than a continued prosecution application under 37 CFR 1.53(d); within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; before the mailing of a first Office Action on the merits, or before the mailing of a first Office Action after the filing of a request for continued examination under 37 CFR 1.114.

37 CFR 1.97(c)

2. ☐ The Information Disclosure Statement submitted herewith is being filed after the period specified in 37 CFR 1.97(b), provided that the Information Disclosure Statement is filed before the mailing date of a Final Action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an Action that otherwise closes prosecution in the application, and is accompanied by one of:

☐ the statement specified in 37 CFR 1.97(e);

OR

☐ the fee set forth in 37 CFR 1.17(p).

RECEIVED
APR 23 2002
TECHNICAL SERVICES 2800

CERTIFICATE OF MAILING BY "EXPRESS MAIL" (37 CFR 1.10)

Applicant(s): Chad Copley

Docket No.

11675.143.2

Serial No.

10/056,350

Filing Date

January 24, 2002

Examiner

Unknown

Group Art Unit

2825

Invention:

PROCESS FOR PROVIDING ELECTRICAL CONNECTION BETWEEN A SEMICONDUCTOR DIE AND A SEMICONDUCTOR DIE RECEIVING MEMBER

I hereby certify that the following correspondence:

Documents as listed below.

(Identify type of correspondence)

is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 in an envelope addressed to: The Assistant Commissioner for Patents, Washington, D.C. 20231 on

April 19, 2002
(Date)



022901

PATENT TRADEMARK OFFICE

Jamie Warner

(Typed or Printed Name of Person Mailing Correspondence)

(Signature of Person Mailing Correspondence)

EL813858240US

("Express Mail" Mailing Label Number)

Note: Each paper must have its own certificate of mailing.

Transmittal Letter (1 pg in dup); Transmittal of IDS (2 pgs dup); IDS (2 pgs); Cited References; Information Disclosure Citation (1 pg); Certificate of Express Mailing Label No. EL813858240US; Postcard



PATENT APPLICATION
Docket No: 11675.143.2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Chad Cobbley

Serial No.: 10/056,350

Filed: January 24, 2002

For: **PROCESS FOR PROVIDING ELECTRICAL
CONNECTION BETWEEN A SEMICONDUCTOR
DIE AND A SEMICONDUCTOR DIE
RECEIVING MEMBER**

Examiner: Unknown

)
)
)
)
) Art Unit
) 2825

TECHNOLOGY CENTER 22600

APR 23 2002

RECEIVED

INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. § 1.97

Moreover, while no representation is made that a specific search of office files or patent office records has been conducted or that no better art exists, the undersigned attorney of record believes that the enclosed art is the closest to the claimed invention (taken in its entirety) of which the undersigned is presently aware, and no art which is closer to the claimed invention (taken in its entirety) has been knowingly withheld.

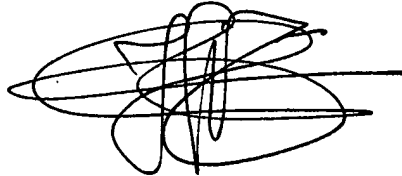
United States Patent Documents

<u>Patent Number</u>	<u>Issue Date</u>	<u>Name</u>	<u>Class</u>	<u>Sub Class</u>
5,578,874	11/96	Kurogi et al	257	778
5,604,383	2/97	Matsuzaki	257	778
5,216,278	6/93	Lin et al	257	688
5,545,923	8/96	Barber	257	691
5,637,920	6/97	Loo	257	700
5,973,403	10/99	Wark	257	777

RECEIVED
APR 23 2002
TECHNICAL CENTER 2800

Dated this 19th day of April, 2002

Respectfully submitted,



Jesús Juanós i Timoneda, Ph. D.
Attorney for Applicant
Registration No. 43,332

WORKMAN, NYDEGGER & SEELEY
1000 Eagle Gate Tower
60 East South Temple
Salt Lake City, Utah 84111
Telephone: (801) 533-9800
Facsimile: (801) 328-1707



022901

PATENT TRADEMARK OFFICE